

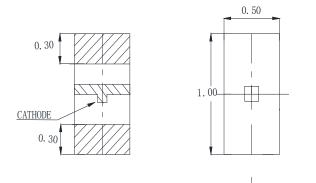
#### **Features**

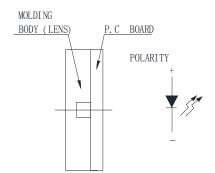
- · 1.0mm\*0.5mm SMT LED, Super thin (0.50H mm)
- · Low Power Consumption
- · Wide Viewing Angle
- · Various Colors
- · Compatible with automatic placement equipment.
- · Compatible with infrared and vapor phase reflow and wave solder process.
- · Meet ROHS Green Product
- · Package: 3000pcs/Reel

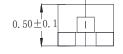
# **Applications**

· Backlight and Indicator

# **Package Dimensions**







## **Notes:**

- 1. All dimensions are in millimeters (inches).
- 2. Tolerance is  $\pm 0.2$ mm(.0079") unless otherwise noted.
- 3. Specifications are subject to change without notice
- 4. This drawing is only for reference, not as a basis for the actual structure.

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## FSL-1005050PG-FAT2NNPR

## **Selection Guide**

Part No	Lens Type	Dice	Emitted Color
FSL-1005050PG-FAT2N NPR	Water Clear	InGaN	Pure Green

# Electrical / Optical Characteristics At Ta=25 °C

Symbol	Parameter		Тур.	Max.	Unit	Test Condition
Iv	Luminous Intensity		56	72	mcd	IF=2mA
201/2	Viewing Angle		130		deg	IF=2mA
入 Peak	Peak Emission Wavelength		518		nm	IF=2mA
入 d	Dominant Wavelength		530		nm	IF=2mA
$\triangle \lambda$	Spectral Line Half-Width		20		nm	IF=2mA
VF	Forward Voltage	2.6	2.9	3.1	V	IF=2mA
IR	Reverse Current			10	μА	VR=5V

Note:

## Absolute Maximum Ratings At Ta=25℃

Parameter	Pure Green	Unit	
Power Dissipation	76	mW	
Peak Forward Current[1]	100	mA	
Continuous Forward Current	30	mA	
Dreading Linear From30℃	0.5	mA/°C	
Reverse Voltage	5	V	
Electrostatic Discharge Threshold(HBM)	300	V	
Operating Temperature Range	-20°C to + 80°C		
Storage Temperature Range	-30°C to + 100°C		
Soldering Condition	260°C For 5 Seconds		

Note:

 $1.\ 1/10 Duty Cycle,\ 0.1 ms Pulse Width$ 

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 $<sup>1.\,\</sup>theta1/2$  is the angle from optical centerline where the luminous intensity is 1/2 optical centerline value



# Electrical Optical Characteristics Curves At Ta=25 °C

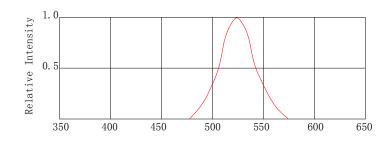


Fig. 1 Relative Intensity vs. Wavelength

Wavelength  $\lambda$  (nm)

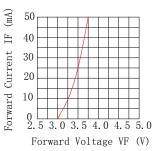


Fig. 2 Forward Current VS. Forward Voltage

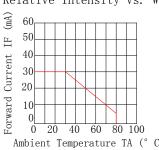


Fig. 3 Forward Current Derating Curve

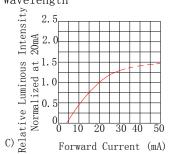
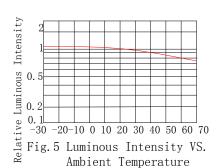
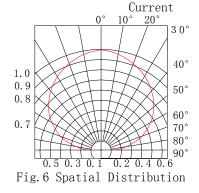


Fig. 4 Relative Luminous
Intensity VS. Forward





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# **Bin Range Of Luminous Intensity**

Symbol	Bin Code	Min.	Max.	Unit	Condition
	K	7	11	mcd	IF=2mA
	L	11	18		
Iv	M	18	28		
	N	28	45		
	P	45	72		

## **Bin Range Of Forward Voltage**

Symbol	Bin Code	Min.	Max.	Unit	Condition
VF	-	2.6	3.1	V	IF=2mA

## **Bin Range Of Dominate Wavelength**

Symbol	Bin Code	Min.	Max.	Unit	Condition
入 d	-	515	535	nm	IF=2mA

#### Notes:

1. Tolerance of Luminous Intensity +/-20%

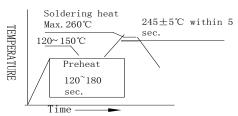
2. Tolerance of Forward Voltage +/-0.2V

3. Tolerance of the Dominate Wavelength +/- 2nm

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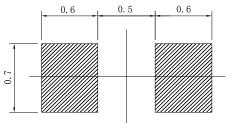
## **SMT Reflow Soldering Instructions**



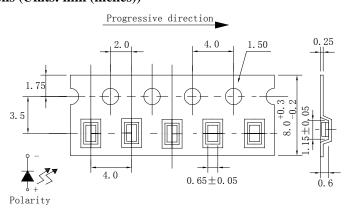
#### Notes:

- Selles gives no other assurances regarding the ability of to withstand ESD. It is recommended to use a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.
- 2. Reflow soldering should not be done more than two times.
- 3. Do not stress LED when soldering, and do not warp the circuit board after soldering
- While using Iron, Power dissipation of Iron should be smaller than 25W, and temperature should be controllable. The work should be finished within 2 sec under 320°C for once only.

#### **Recommended Soldering Pad Dimensions**



## Package Specifications (Units: mm (inches))



### Notes:

- 1. The LEDs should be used within a year.
- The LEDs should be kept in 5~30°C and 60% RH for less. 2.
- The LEDs should be used within 24 hours, or else should be kept a 5~30°C and 30% RH or less. And LEDs should be used within 7 days after opening the package.

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### FSL-1005050PG-FAT2NNPR

# **Reliability Test Items Conditions**

Classification	Test Item	Test Conditions	Test hours	Result
	Operation Life	Connect with a power IF=5mA Ta=Under room temperature	1000Hrs	0/20
F 1	High Temperature High Humidity	Ta=+65°C±5°C RH=90%-95%	240Hrs	0/20
Endurance Test	High Temperature Storage	High Ta=+85°C±5°C	1000Hrs	0/20
	Low Temperature Storage	Low Ta=-35°C±5°C Test time=1000hrs	1000Hrs	0/20
	Temperature Cycling	-45°C ~+105°C 15min 5min 15min	300 Cycles	0/20
Environmental	Thermal Shock	-35°C ~±5°C ~+85°C ~±5°C 5min 10sec 5min	300 Cycles	0/20
Test Solder Resistance		Preheating: 120°C-150°C, within 2 minutes. Operation heating: 260°C (Max.), within 5 seconds (Max.)	5Cycles	0/20

# Judgment criteria of failure for the reliability

Measuring items	Symbol	Measuring conditions	Judgment criteria for failure
Forward voltage	V <sub>F</sub> (V)	IF=5mA	Over U×1.2
Reverse current	Ir(µA)	V <sub>R</sub> =5V	Over U×2
Luminous intensity	Iv(mcd)	Ir=5mA	Below S×0.5

Note: 1.U means the upper limit of specified characteristics. S means initial value.

2.Meansurment shall be taken between 2 hours after the test pieces have been returned to normal ambient conditions after completion of each test.

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